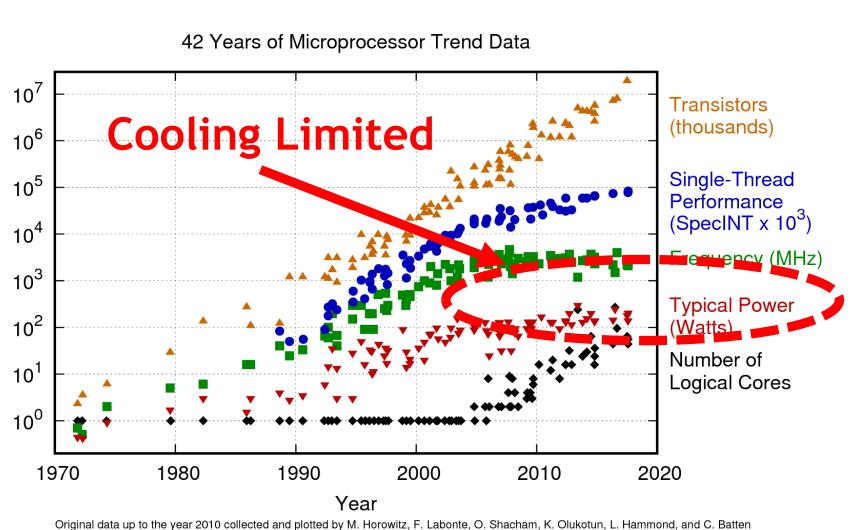
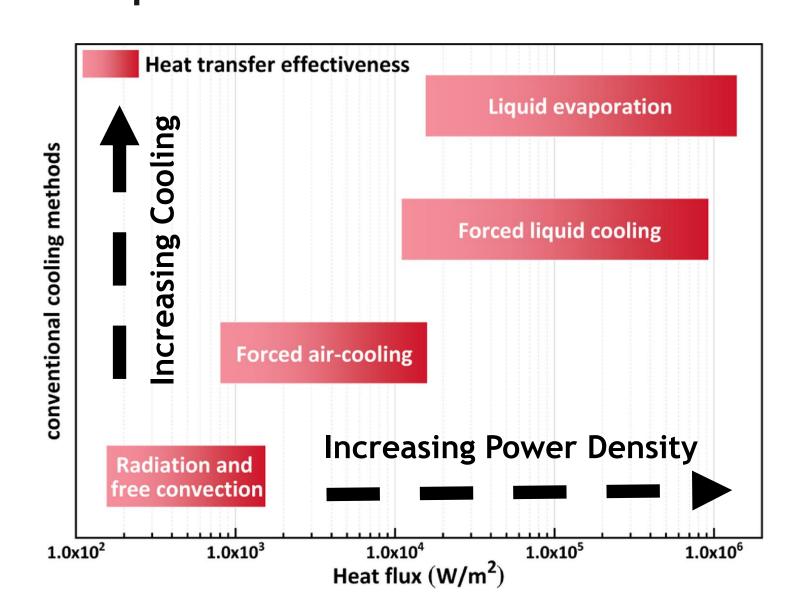
Fluid Motion of Fluid Filled Heat Sinks

Background

- Heat dissipation devices, such as heat sinks, heat spreaders, and heat pipes, are essential in many applications to prevent component failure.
- The rapid advancement of technology and a continual increase in power density drive the need for lighter and more compact heat dissipation devices.



Microprocessor Historical Power Trends



Conventional Cooling Methods [1]

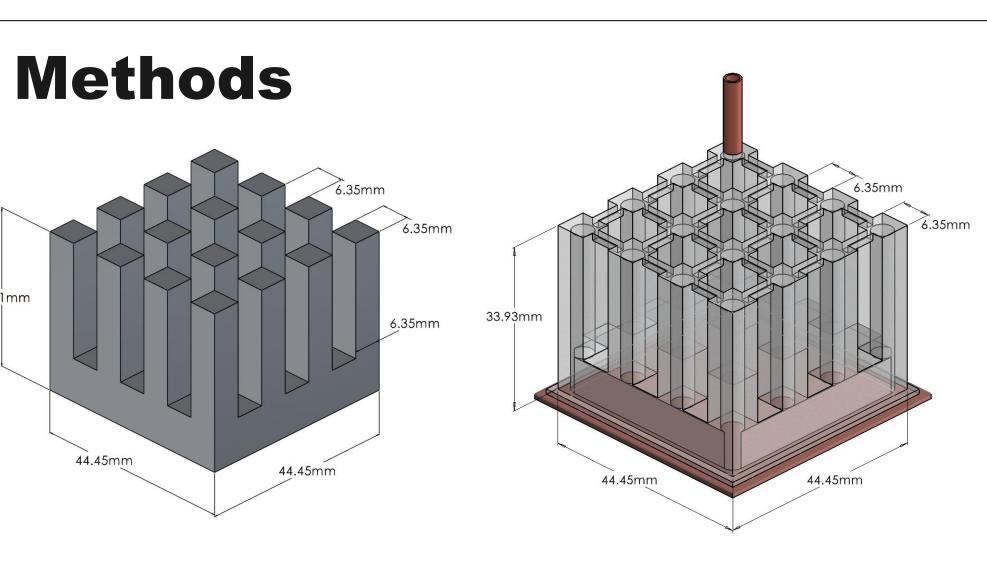
Preliminary Research

- Previous research was done to determine whether a hollow heat sink filled with fluid is more effective than solid heat sinks for heat dissipation.
- The study designed, developed, and tested hollow copper and aluminum heat sinks filled with water and acetone, respectively and compared the two heat sinks to solid versions.
- Each heat sink was tested at nine operating points (varying applied heats and air velocities).
- The hollow copper heat sink had approximately the same overall heat sink thermal resistance while the hollow aluminum increased by 7%.
- The considerable decrease in mass without significant loss in thermal resistance demonstrates the potential widespread application across technologies requiring lowweight components.

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Objective

• In this study, the goal is to observe the fluid motion in a fluid-filled fin array to determine how the water assists the heat dissipation. The hollow structure of fluid-filled fin array integrates characteristics of both heat sinks and heat pipes.



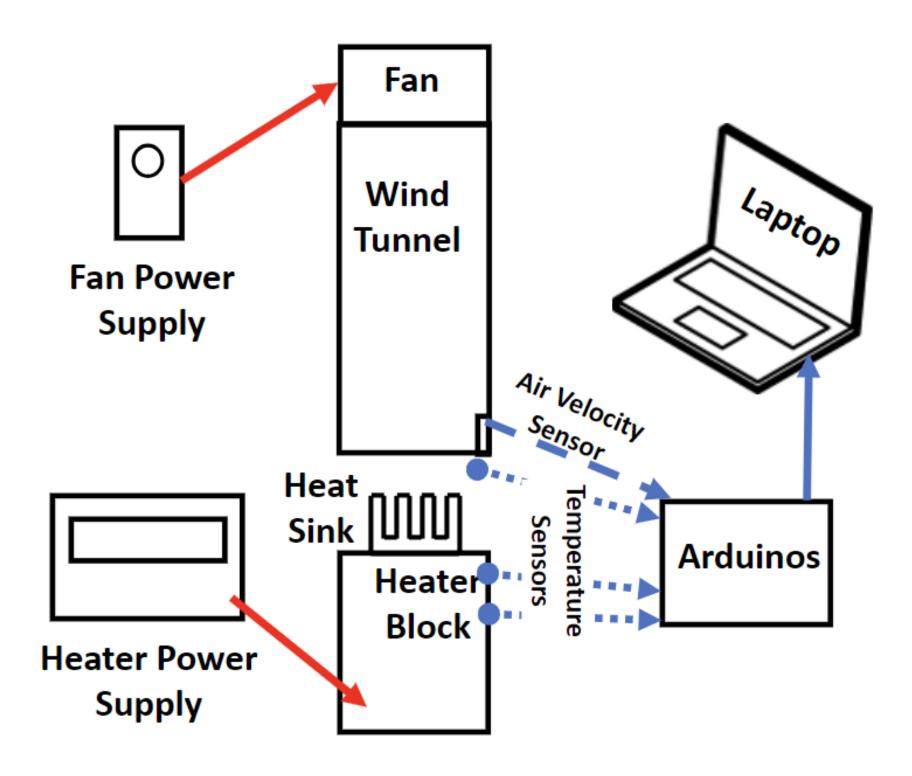
Solid Heat Sink (not tested)

Hollow Clear Resin Heat Sink (tested)

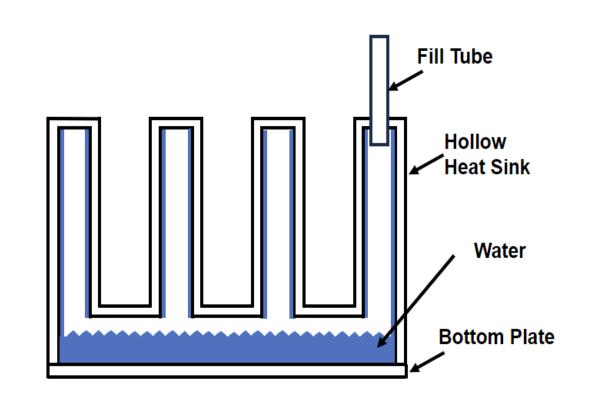
The heat sink was SLA printed from a high temperature clear resin and epoxied onto the copper base plate to better see the motion within the heat sink.

The heat sink was evacuated using a vacuum pump and filled with a syringe.

• The working fluid was water with a 33% fill volume.



Schematic of Experiment Setup

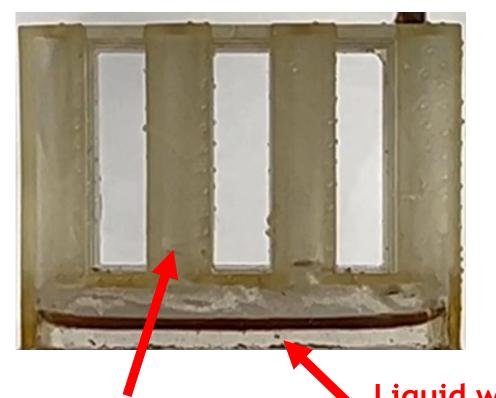


Schematic of Clear Resin Heat Sink

Theory

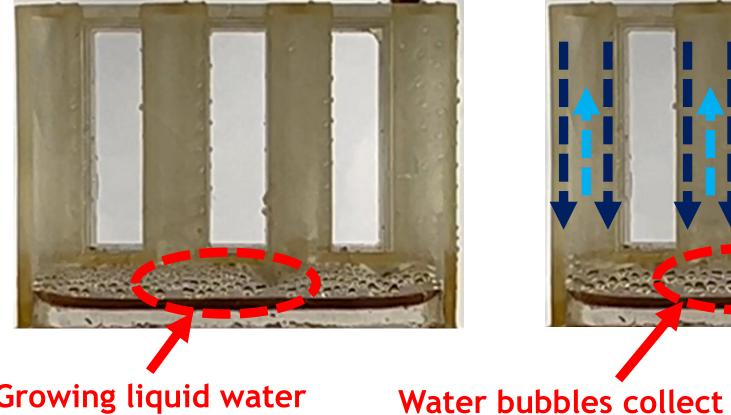
- transfer.
- evaporator, • Wickless heat pipes





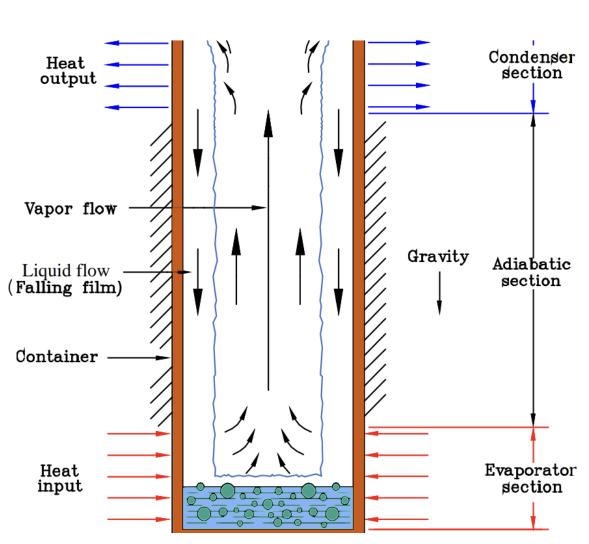
Water vapor at the top and inside the fins

After ~8 minutes



Growing liquid water bubbles on the walls

Heat pipes utilize fluid phase changes to assist in heat They contain an condenser, and adiabatic section.



rely on gravity to let the condensed working fluid flow down the walls to the evaporator section.

Gravity-Assisted Wickless Heat Pipe [2]

- video documentation.
- - - water vapor

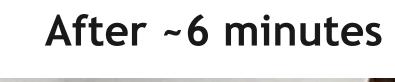
 - the bottom

Experimental Results

◆ Tested at 60 W, 5 m/s, transient ♦ 16 minutes long video collected Important frames are shown below

Start of Heating

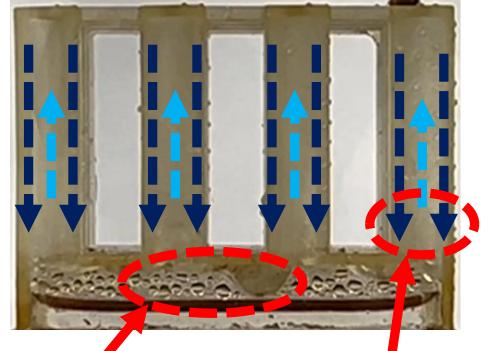
Liquid water at the bottom





Small condensed water bubbles forming on the walls After ~11 minutes





and fall to the

liquid at the bottom

Vapor in the center and liquid along the walls

Acknowledgements

- Construction

References

- Pipes (FHP), 5(1).



Conclusions and Recommendations

The anticipated fluid motion of the heat sink was validated through experimental observation and

The evaporator, condenser, and adiabatic sections of the hollow heat sink were clearly identified by utilizing a transparent resin model.

The video footage captured the following phases: Condensed water on the heat sink walls Water vapor in the center of the fins

• Bubble formation from the condensing

Water bubble growth

• Falling water bubbles back to the liquid at

• UNF's College of Computing, Engineering, and

• UNF's Office of Undergraduate Research

Zhang, Z., Wang, X., & Yan, Y. (2021). A review of the state-of-the-art in electronic cooling. e-Prime-Advances in Electrical Engineering, Electronics and Energy, 1, 100009. 2. Faghri, A. (2014). Heat pipes: review, opportunities and challenges. Frontiers in Heat doi: https://doi.org/10.5098/fhp.5.1.

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